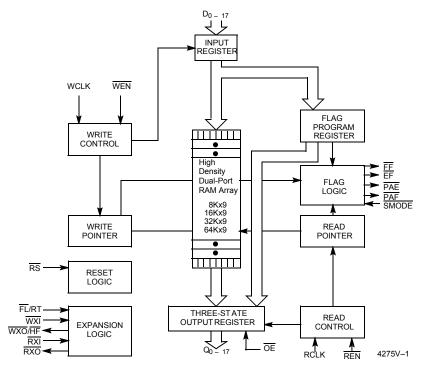


Parameter	CY7C4255V	CY7C4265V	CY7C4275V	CY7C4285V
Density	8 K × 18	16 K × 18	32 K × 18	64 K × 18
Package	64-pin 10×10 TQFP	64-pin 10×10 TQFP	64-pin 10×10 TQFP	64-pin 10×10 TQFP

Logic Block Diagram





CY7C4255V, CY7C4265V CY7C4275V, CY7C4285V

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Pinouts

Figure 1. Pin Diagram - 64-pin STQFP Q₁₅ V_{CC}/SMODE **Top View** D₁₆ D₁₇ GND RCLK Q₁₆ GND 0¹⁷ Q₁₄ D₁₅ D₁₄ 2 47 Q₁₃ D₁₃ 46 GND 3 4 Т 45 Q₁₂ D₁₂ ٦. Q₁₁ 44 5 D₁₁ D₁₀ 6 43 V_{CC} CY7C4255V D₉ 7 42 Q₁₀ CY7C4265V 41 Q9 D8 8 I 40 39 38 37 GND D7 🗖 9 CY7C4275V D₆ 10 Q_8 D5 🗖 11 Q7 I CY7C4285V D4 12 Q_6 Т D3 🗖 36 35 34 33 13 Q_5 Т D₂ 14 15 GND Т D₁ Q4 D₀ V_{CC} Т 4275V-3 PAE FURT WCLK WEN WEN WEN VCC PAF RXI FF RXI RXI စိုင်္ခ ရှိန်နိုင်ငံ စိ



Table 1. Pin Definitions - CY7C4255/65/75/85V 64-pin STQFP

Signal Name	Description	ю	Function
D ₀₋₁₇	Data Inputs	Ι	Data inputs for an 18-bit bus.
Q ₀₋₁₇	Data Outputs	0	Data outputs for an 18-bit bus.
WEN	Write Enable	I	Enables the WCLK input.
REN	Read Enable	Ι	Enables the RCLK input.
WCLK	Write Clock	I	The rising edge clocks data into the FIFO when $\overline{\text{WEN}}$ is LOW and the FIFO is not Full. When $\overline{\text{LD}}$ is asserted, WCLK writes data into the programmable flag-offset register.
RCLK	Read Clock	I	The rising edge clocks data out of the FIFO when $\overline{\text{REN}}$ is LOW and the FIFO is not Empty. When $\overline{\text{LD}}$ is asserted, RCLK reads data out of the programmable flag-offset register.
WXO/HF	Write Expansion Out/Half Full Flag	0	Dual Mode Pin: Single device or width expansion – Half Full status flag Cascaded – Write Expansion Out signal, connected to WXI of next device
EF	Empty Flag	0	When EF is LOW, the FIFO is empty. EF is synchronized to RCLK.
FF	Full Flag	0	When FF is LOW, the FIFO is full. FF is synchronized to WCLK.
PAE	Programmable Almost Empty	0	When $\overrightarrow{\text{PAE}}$ is LOW, the FIFO is almost empty based on the almost empty offset value programmed into the FIFO. $\overrightarrow{\text{PAE}}$ is asynchronous when V _{CC} / $\overrightarrow{\text{SMODE}}$ is tied to V _{CC} . It is synchronized to RCLK when V _{CC} / $\overrightarrow{\text{SMODE}}$ is tied to V _{SS} .
PAF	Programmable Almost Full	0	When $\overline{\text{PAF}}$ is LOW, the FIFO is almost full based on the almost full offset value programmed into the FIFO. $\overline{\text{PAF}}$ is asynchronous when $V_{CC}/\overline{\text{SMODE}}$ is tied to V_{CC} . It is synchronized to WCLK when $V_{CC}/\overline{\text{SMODE}}$ is tied to V_{SS} .
LD	Load	I	When $\overline{\text{LD}}$ is LOW, D ₀₋₁₇ (Q ₀₋₁₇) are written (read) into (from) the programmable-flag-offset register.
FL/RT	First Load/ Retransmit	I	Dual Mode Pin: Cascaded – The first device in the daisy chain has \overline{FL} tied to V_{SS} ; all other devices have \overline{FL} tied to V_{CC} . In standard mode or width expansion, \overline{FL} is tied to V_{SS} on all devices. Not Cascaded – Tied to V_{SS} . Retransmit function is also available in standalone mode by strobing RT.
WXI	Write Expansion Input	I	Cascaded – Connected to WXO of previous device Not Cascaded – Tied to V _{SS}
RXI	Read Expansion Input	I	Cascaded – Connected to RXO of previous device Not Cascaded – Tied to V _{SS}
RXO	Read Expansion Output	0	Cascaded – Connected to RXI of next device
RS	Reset	Ι	Resets device to empty condition. A reset is required before an initial read or write operation after power up.
ŌĒ	Output Enable	I	When OE is LOW, the FIFO's data outputs drive the bus to which they are connected. If OE is HIGH, the FIFO's outputs are in High Z (high-impedance) state.
V _{CC} /SMODE	Synchronous Almost Empty/ Almost Full Flags	Ι	Dual Mode Pin: Asynchronous Almost Empty/Almost Full flags – tied to V _{CC} Synchronous Almost Empty/Almost Full flags – tied to V _{SS} (Almost Empty synchronized to RCLK, Almost Full synchronized to WCLK.)



Functional Description

The CY7C4255/65/75/85V provides five status pins. These pins are decoded to determine one of five states: Empty, Almost Empty, Half Full, Almost Full, and Full (see Table 3 on page 7). The Half Full flag shares the WXO pin. This flag is valid in the standalone and width expansion configurations. In the <u>depth</u> expansion, this pin provides the expansion out (WXO) information that is used to signal the next FIFO when it is to be activated.

The Empty and Full flags are synchronous, that is, they change state relative to either the read clock (RCLK) or the write clock (WCLK). When entering or exiting the Empty states, the flag is updated exclusively by the RCLK. The flag denoting Full states is updated exclusively by WCLK. The synchronous flag architecture guarantees that the flags remain valid from one clock cycle to the next. The Alm<u>ost Empty</u>/Almost Full flags become synchronous if the V_{CC}/SMODE is tied to V_{SS}. All configurations are fabricated using an advanced 0.35 μ CMOS technology. Input ESD protection is greater than 2001 V, and latch-up is prevented by the use of guard rings.

Architecture

The CY7C4255/65/75/85V consists of an array of 8K/16K/32K/64K words of 18 bits each (implemented by a dual port array of SRAM cells), a read pointer, a write pointer, control signals (RCLK, WCLK, REN, WEN, RS), and flags (EF, PAE, HF, PAF, FF). The CY7C4255/65/75/85V also includes the control signals WXI, RXI, WXO, RXO for depth expansion.

Resetting the FIFO

Upon power up, the FIFO must be reset with a Reset (\overline{RS}) cycle. <u>This</u> causes the FIFO to enter the Empty condition signified by <u>EF</u> being LOW. All data outputs go LOW after the falling edge of RS only if \overline{OE} is asserted. For the FIFO to reset to its default state, the user must not read or write while RS is LOW.

FIFO Operation

When the WEN signal is active (LOW), data present on the D₀₋₁₇ pins is written into the FIF<u>O</u> on each rising edge of the WCLK signal. Similarly, when the REN signal is active LOW, data in the FIFO memory is presented on the Q₀₋₁₇ outputs. New data is presented on each rising edge of RCLK while REN is active LOW and OE is LOW. REN must set up t_{ENS} before RCLK for it to be a valid read function. WEN must occur t_{ENS} before WCLK for it to be a valid write function.

An output enable (\overline{OE}) pin is provided to three-state the Q_{0-17} outputs when \overline{OE} is deasserted. When \overline{OE} is enabled (LOW), data in the output register is available to the Q_{0-17} outputs after t_{OE} . If devices are cascaded, the \overline{OE} function only outputs data on the FIFO that is read enabled.

The FIFO contains overflow circuitry to disallow additional writes when the FIFO is full, and under flow circuitry to disallow additional reads when the FIFO is empty. An empty FIFO maintains the data of the last valid read on its Q_{0-17} outputs even after additional reads occur.

Note

1. The same selection sequence applies to reading from the registers. REN is enabled and read is performed on the LOW-to-HIGH transition of RCLK.

Programming

The CY7C4255/65/75/85V devices contain two 16-bit offset registers. Data present on D_{0-15} during a program write determine the distance from Empty (Full) that the Almost Empty (Almost Full) flags become active. If the user elects not to program the FIFO's flags, the default offset values are used (see Table 3 on page 7). When the Load LD pin is set LOW and WEN is set LOW, data on the inputs D_{0-15} is written into the Empty offset register on the first LOW-to-HIGH transition of the write clock (WCLK). When the LD pin and WEN are held LOW then data is written into the Full offset register on the second LOW-to-HIGH transition of the write clock (WCLK). The third transition of the write clock (WCLK) again writes to the Empty offset register (see Table 2). All offset registers do not have to be written at one time. One or two offset registers can be written and then, by bringing the LD pin HIGH, the FIFO is returned to normal read/write operation. When the LD pin is set LOW, and WEN is LOW, the next offset register in sequence is written.

The contents of the offset registers can be read on the output lines when the LD pin is set LOW and REN is set LOW. Then, data can be read on the LOW-to-HIGH transition of the read clock (RCLK).

Table 2.	Write	Offset	Register
----------	-------	--------	----------

LD	WEN	WCLK ^[1]	Selection
0	0		Writing to offset registers: Empty Offset Full Offset
0	1		No Operation
1	0		Write Into FIFO
1	1		No Operation

Flag Operation

The CY7C4255/65/75/85V devices provide five flag pins to indicate the condition of the FIFO contents. Empty and Full are synchronous. PAE and PAF are synchronous if V_{CC}/SMODE is tied to V_{SS}.

Full Flag

The Full Flag (FF) goes LOW when device is Full. Write operations are inhibited whenever FF is LOW regardless of the state of WEN. FF is synchronized to WCLK, that is, it is exclusively updated by each rising edge of WCLK.

Empty Flag

The Empty Flag (\overline{EF}) goes LOW when the device is empty. Read operations are inhibited whenever \overline{EF} is LOW, regardless of the state of REN. \overline{EF} is synchronized to RCLK, that is, it is exclusively updated by each rising edge of RCLK.

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Programmable Almost Empty/Almost Full Flag

The CY7C4255/65/75/85V features programmable Almost Empty and Almost Full Flags. Each flag can be programmed (described in section Programming on page 6) a specific distance from the corresponding boundary flags (Empty or Full). When the FIFO contains the number of words or fewer for which the flags have been programmed, the \overrightarrow{PAF} or \overrightarrow{PAE} is asserted, signifying that the FIFO is either Almost Full or Almost Empty. See Table 3 for a description of programmable flags.

When the SMODE pin is tied LOW, the PAF flag signal transition is caused by the rising edge of the write clock and the PAE flag transition is caused by the rising edge of the read clock.

Table 3. Flag Truth Table

	Number of Words in FIFO						PAE	EF
7C4255V – 8 K × 18	7C4265V – 16 K × 18	7C4275V – 32 K × 18	7C4285V – 64 K × 18	FF	PAF	HF		
0	0	0	0	Н	Н	Н	L	L
1 to n ^[2]	1 to n ^[2]	1 to n ^[2]	1 to n ^[2]	Н	Н	Н	L	Н
(n+1) to 4096	(n+1) to 8192	(n+1) to 16384	(n+1) to 32768	Н	Н	Н	Н	Н
4097 to (8192–(m+1))	8193 to (16384 –(m+1))	16385 to (32768–(m+1))	32769 to (65536 –(m+1))	Н	Н	L	Н	Н
(8192–m) ^[3] to 8192	(16384–m) ^[3] to 16384	(32768–m) ^[3] to 32767	(65536–m) ^[3] to 65535	Н	L	L	Н	Н
8192	16384	32768	65536	L	L	L	Н	Н

Retransmit

The retransmit feature is beneficial when transferring packets of data. It enables the receipt of data to be acknowledged by the receiver and retransmitted if necessary.

The Retransmit (RT) input is active in the standalone and width expansion modes. The retransmit feature is intended for use when a number of writes equal to or less than the depth of the FIFO have occurred and at least one word has been read since the last RS cycle. A HIGH pulse on RT resets the internal read pointer to the first physical location of the FIFO. WCLK and RCLK may be free running but must be disabled during and t_{RTR} after the retransmit pulse. With every valid read cycle after retransmit, previously accessed data is read and the read pointer is incremented until it is equal to the write pointer. Flags are governed by the relative locations of the read and write pointers and are updated during a retransmit cycle. Data written to the FIFO after activation of RT are transmitted also. The full depth of the FIFO can be repeatedly retransmitted.

Width Expansion Configuration

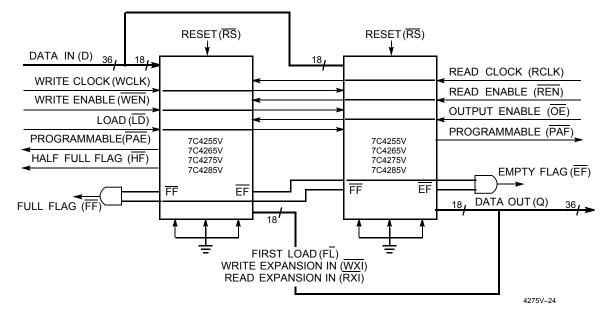
The CY7C4255/65/75/85V can be expanded in width to provide word widths greater than 18 in increments of 18. During width expansion mode, all control line inputs are common and all flags are available. Empty (Full) flags must be created by ANDing the Empty (Full) flags of every FIFO. The PAE and PAF flags can be detected from any one device. This technique avoids reading data from, or writing data to the FIFO that is "staggered" by one clock cycle due to the variations in skew between RCLK and WCLK. Figure 2 on page 8 demonstrates a 36-word width by using two CY7C4255/65/75/85Vs.

Notes

n = Empty Offset (Default Values: CY7C4255/65/75/85V n = 127).
 m = Full Offset (Default Values: CY7C4255/65/75/85V n = 127).



Figure 2. Block Diagram of 8 K/16 K/32 K/64 K × 18 Low Voltage Synchronous FIFO Memory in Width Expansion Configuration



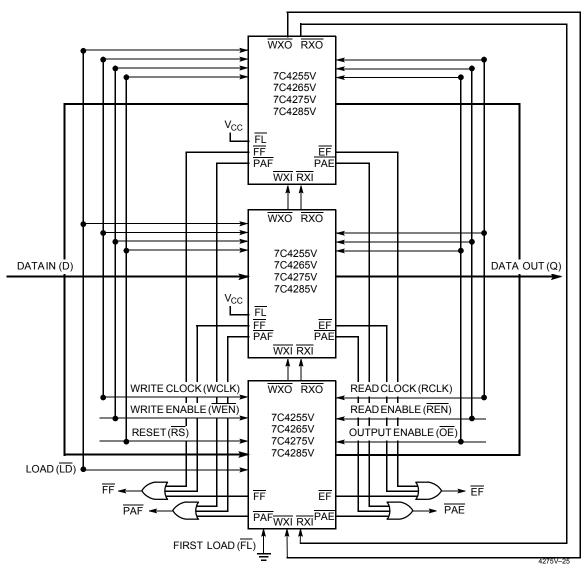
Depth Expansion Configuration (with Programmable Flags)

The CY7C4255/65/75/85V can easily be adapted to applications requiring more than 8 K/16 K/32 K/64 K words of buffering. Figure 3 on page 9 shows Depth Expansion using three CY7C4255/65/75/85Vs. Maximum depth is limited only by signal loading. Follow these steps:

- 1. The first device must be designated by grounding the First Load (FL) control input.
- 2. All other devices must have FL in the HIGH state.
- 3. The Write Expansion Out (WXO) pin of each device must be tied to the Write Expansion In (WXI) pin of the next device.
- 4. The Read Expansion Out (RXO) pin of each device must be tied to the Read Expansion In (RXI) pin of the next device.
- 5. All Load (LD) pins are tied together.
- 6. The Half Full Flag (\overline{HF}) is not available in the Depth Expansion Configuration.
- 7. <u>EF</u>, FF, <u>PAE</u>, and <u>PAF</u> are created with composite flags by ORing together these respective flags for monitoring. The composite PAE and PAF flags are not precise.









Maximum Ratings

Exceeding maximum ratings^[4] may impair the useful life of the device. These user guidelines are not tested.

Storage Temperature65 °C to +150 °C
Ambient Temperature with Power Applied
Supply Voltage to Ground Potential–0.5 V to V _{CC} + 0.5 V
DC Voltage Applied to Outputs in High Z State0.5 V to V _{CC} + 0.5 V
DC Input Voltage $-0.5 \text{ V to V}_{CC} + 0.5 \text{ V}$

Output Current into Outputs (LOW)	20 mA
Static Discharge Voltage (per MIL–STD–883, Method 3015)	> 2001 V
Latch-Up Current	>200 mA

Operating Range

Range	AmbientTemperature	V_{CC} ^[5]
Commercial	0 °C to +70 °C	3.3 V ± 300 mV
Industrial ^[6]	–40 °C to +85 °C	3.3 V ± 300 mV

Electrical Characteristics

Over the Operating Range [7]

Parameter	Description	Test Con	ditiona	7C4255	/85V-10	7C4255/65/75/85V-15		Unit
Parameter	Description	Test Conditions		Min	Max	Min	Max	
V _{OH}	Output HIGH Voltage	V_{CC} = Min, I _{OH} V_{CC} = 3.0 V. I _O	2.4		2.4		V	
V _{OL}	Output LOW Voltage	V_{CC} = Min, I _{OL} = 4.0 mA V _{CC} = 3.0 V, I _{OL} = 8.0 mA			0.4		0.4	V
V _{IH} ^[8]	Input HIGH Voltage			2.0	V _{CC}	2.0	V _{CC}	V
V _{IL} ^[8]	Input LOW Voltage			-0.5	0.8	-0.5	0.8	V
I _{IX}	Input Leakage Current	V _{CC} = Max		-10	+10	-10	+10	μA
I _{OZL} I _{OZH}	Output OFF, High Z Current	$\overline{OE} \ge V_{IH}, V_{SS} <$	< V _O < V _{CC}	-10	+10	-10	+10	μA
I _{CC1} ^[9]	Active Power Supply		Commercial		30		30	mA
	Current		Industrial				35	mA
I _{SB} ^[10]	Average Standby Current		Commercial		4		4	mA
			Industrial				4	mA

Capacitance

Parameter ^[11]	Description	Test Conditions	Мах	Unit
C _{IN}	Input Capacitance	T _A = 25 °C, f = 1 MHz, V _{CC} = 3.3 V	5	pF
C _{OUT}	Output Capacitance		7	pF

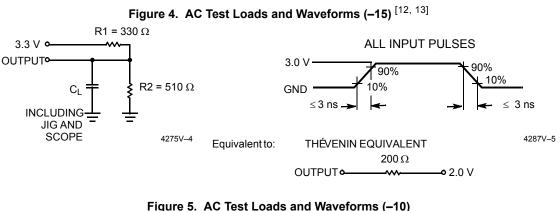
Notes

- 4. The Voltage on any input or IO pin cannot exceed the power pin during power up.
- 5. V_{CC} range for commercial -10 ns is 3.3 V ± 150 mV. 6. T_A is the "instant on" case temperature.

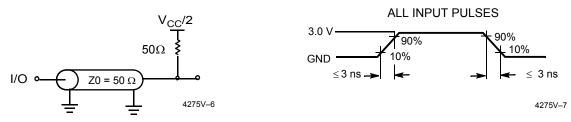
- A for the last page of this specification for Group A subgroup testing information.
 The V_{IH} and V_{IL} specifications apply for all inputs except WXI, RXI. The WXI, RXI pin is not a TTL input. It is connected to either RXO, WXO of the previous device or V_{SS}.
- Input signals switch from 0 V to 3 V with a rise/fall time of less than 3 ns, clocks and clock enables switch at 20 MHz, while data inputs switch at 10 MHz. Outputs 9. are unloaded.

10. All inputs = V_{CC} – 0.2 V, except RCLK and WCLK (which are at frequency = 0 MHz), and \overline{FL}/RT which is at V_{SS} . All outputs are unloaded. 11. Tested initially and after any design changes that may affect these parameters.









Notes 12. C_L = 30 pF for all AC parameters except for t_{OHZ} . 13. C_L = 5 pF for t_{OHZ} .

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Switching Characteristics

Over the Operating Range

Parameter	Description		7C4255/85V-10		7C4255/65/75/85V-15	
	Description	Min	Max	Min	Max	Unit
t _S	Clock Cycle Frequency		100		66.7	MHz
t _A	Data Access Time	2	8	2	10	ns
t _{CLK}	Clock Cycle Time	10		15		ns
t _{CLKH}	Clock HIGH Time	4.5		6		ns
t _{CLKL}	Clock LOW Time	4.5		6		ns
t _{DS}	Data Setup Time	3.5		4		ns
t _{DH}	Data Hold Time	0		0		ns
t _{ENS}	Enable Setup Time	3.5		4		ns
t _{ENH}	Enable Hold Time	0		0		ns
t _{RS}	Reset Pulse Width ^[14]	10		15		ns
t _{RSR}	Reset Recovery Time	8		10		ns
t _{RSF}	Reset to Flag and Output Time		10		15	ns
t _{PRT}	Retransmit Pulse Width	60		60		ns
t _{RTR}	Retransmit Recovery Time	90		90		ns
t _{OLZ}	Output Enable to Output in Low Z ^[15]	0		0		ns
t _{OE}	Output Enable to Output Valid	3	7	3	10	ns
t _{OHZ}	Output Enable to Output in High Z ^[15]	3	7	3	8	ns
t _{WFF}	Write Clock to Full Flag		8		10	ns
t _{REF}	Read Clock to Empty Flag		8		10	ns
t _{PAFasynch}	Clock to Programmable Almost Full Flag ^[16]		15		16	ns
	(Asynchronous mode, V_{CC} /SMODE tied to V_{CC})					
t _{PAFsynch}	Clock to Programmable Al <u>most Ful</u> l Flag (Synchronous mode, V _{CC} /SMODE tied to V _{SS})		8		10	ns
t _{PAEasynch}	Clock to Programmable Almost Empty Flag ^[16] (Asynchronous mode, V _{CC} /SMODE tied to V _{CC})		15		16	ns
t _{PAEsynch}	Clock to Programmable Almost Full Flag (Synchronous mode, V _{CC} /SMODE tied to V _{SS})		8		10	ns
t _{HF}	Clock to Half Full Flag		12		16	ns
t _{XO}	Clock to Expansion Out		6		10	ns
t _{XI}	Expansion in Pulse Width	4.5		6.5		ns
t _{XIS}	Expansion in Setup Time	4		5		ns
t _{SKEW1}	Skew Time between Read Clock and Write Clock for Full Flag	5		6		ns
t _{SKEW2}	Skew Time between Read Clock and Write Clock for Empty Flag	5		6		ns
t _{SKEW3}	Skew Time between Read Clock and Write Clock for Programmable Almost Empty and Programmable Almost Full Flags (Synchronous Mode only)	10		15		ns

Notes

- Pulse widths less than minimum values are not allowed.
 Values guaranteed by design, not currently tested.
 t_{PAFasynch}, t_{PAEasynch}, after program register write are valid until 5 ns + t_{PAF(E)}.



Switching Waveforms

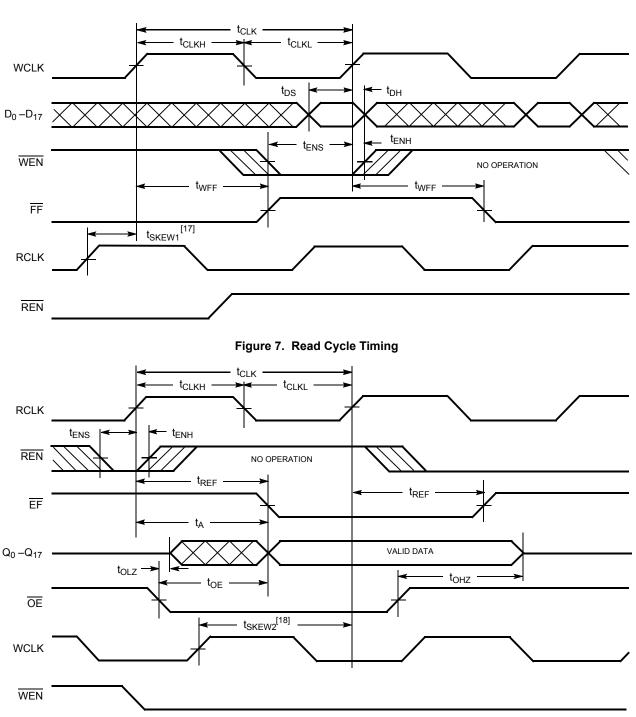
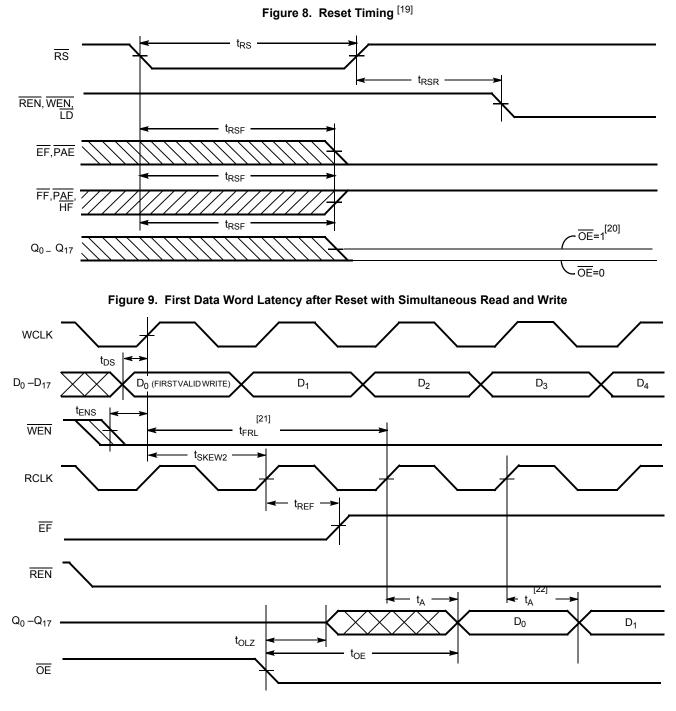


Figure 6. Write Cycle Timing

Notes

- 17. t_{SKEW1} is the minimum time between a rising RCLK edge and a rising WCLK edge to guarantee that FF goes HIGH during the current clock cycle. If the time between the rising edge of RCLK and the rising edge of WCLK is less than t_{SKEW1}, then FF may not change state until the next WCLK rising edge.
- 18. t_{SKEW2} is the minimum time between a rising WCLK edge and a rising RCLK edge to guarantee that EF goes HIGH during the current clock cycle. If the time between the rising edge of WCLK and the rising edge of RCLK is less than t_{SKEW2}, then EF may not change state until the next RCLK rising edge.





Notes

19. The clocks (RCLK, WCLK) can be free-running during reset.

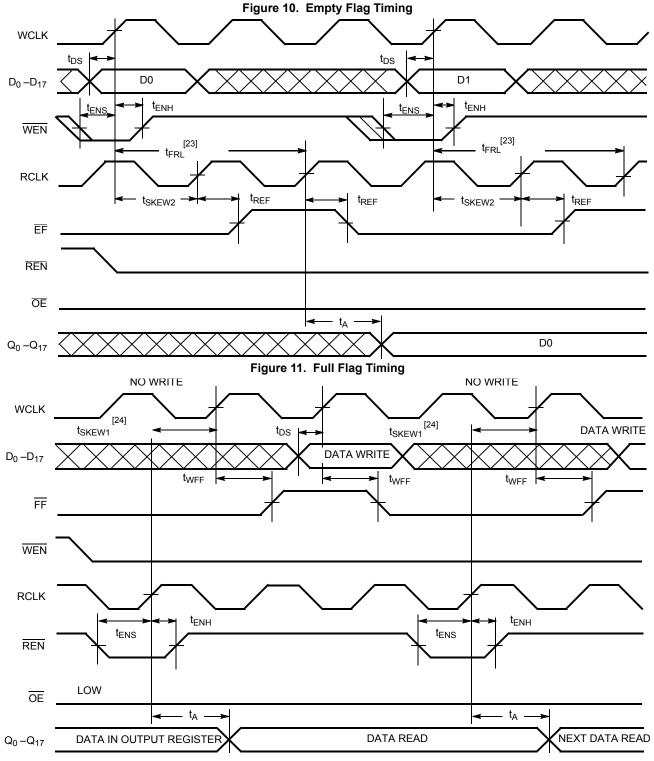
20. After reset, the outputs are LOW if \overline{OE} = 0 and three-state if \overline{OE} = 1.

21. When $t_{SKEW2} \ge$ minimum specification, t_{FRL} (maximum) = $t_{CLK} + t_{SKEW2}$. When $t_{SKEW2} <$ minimum specification, t_{FRL} (maximum) = either 2 × $t_{CLK} + t_{SKEW2}$ or $t_{CLK} + t_{SKEW2}$. The Latency Timing applies only at the Empty Boundary ($\overline{EF} = LOW$).

22. The first word is always available the cycle after $\overline{\text{EF}}$ goes HIGH.

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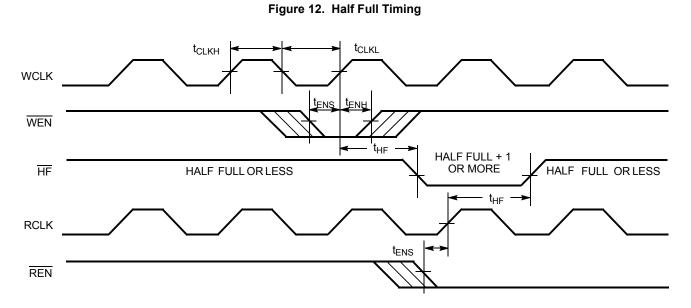


Notes

23. When $t_{SKEW2} \ge minimum$ specification, t_{FRL} (maximum) = $t_{CLK} + t_{SKEW2}$. When $t_{SKEW2} < minimum$ specification, t_{FRL} (maximum) = either 2 × $t_{CLK} + t_{SKEW2}$ or $t_{CLK} + t_{SKEW2}$. The Latency Timing applies only at the Empty Boundary ($\overline{EF} = LOW$).

24. t_{SKEW1} is the minimum time between a rising RCLK edge and a rising WCLK edge to guarantee that FF goes HIGH during the current clock cycle. If the time between the rising edge of RCLK and the rising edge of WCLK is less than t_{SKEW1}, then FF may not change state until the next WCLK rising edge.







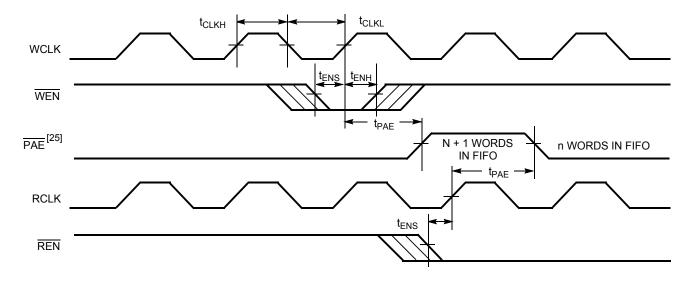




Figure 14. Programmable Almost Empty Flag Timing (applies only in SMODE (SMODE is LOW))

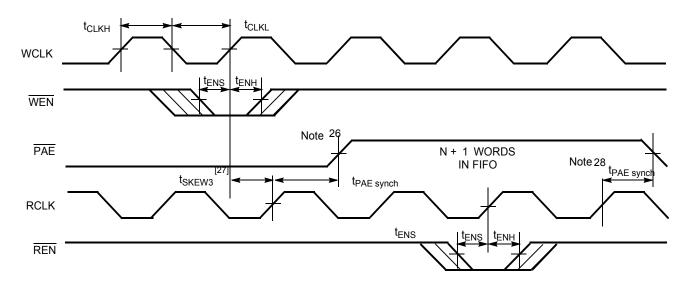
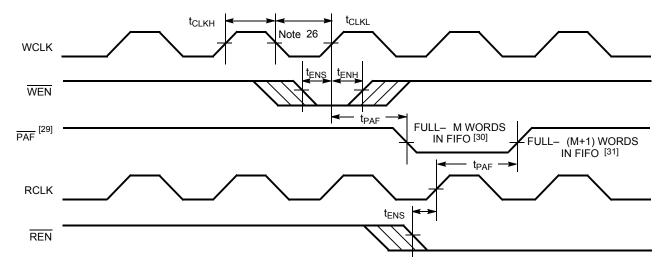


Figure 15. Programmable Almost Full Flag Timing



Notes

- 26. PAF offset = m. Number of data words written into FIFO already = 8192 (m + 1) for the CY7C4255V, 16384 (m + 1) for the CY7C4265V, 32768 (m + 1) for the CY7C4275V, and 65536 (m + 1) for the CY7C4285V.
- 27. t_{SKEW3} is the minimum time between a rising WCLK and a rising RCLK edge for PAE to change state during that clock cycle. If the time between the edge of WCLK and the rising RCLK is less than tSKEW3, then PAE may not change state until the next RCLK.
- 28. If a read is performed on this rising edge of the read clock, there are Empty + (n-1) words in the FIFO when PAE goes LOW.

29. PAF is offset = m.

- 30.8192 m words in CY7C4255V, 16384 m words in CY7C4265V, 32768 m words in CY7C4275V, and 65536 m words in CY7C4285V.
- 31.8192 (m + 1) words in CY7C4255V, 16384 (m + 1) words in CY7C4265V, 32768 (m + 1) words in CY7C4275V, and 65536 (m + 1) words in CY7C4285V.



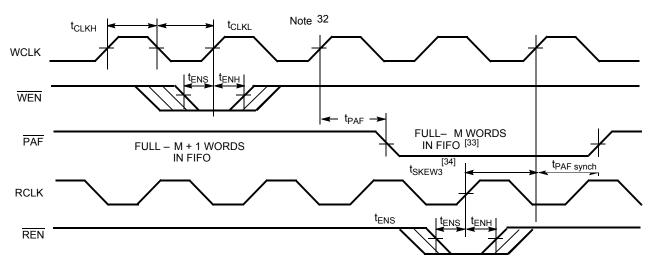
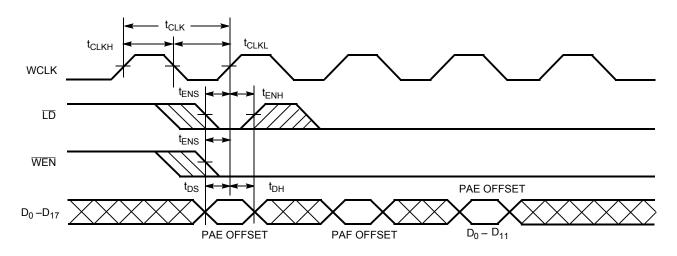


Figure 16. Programmable Almost Full Flag Timing (applies only in SMODE (SMODE is LOW))

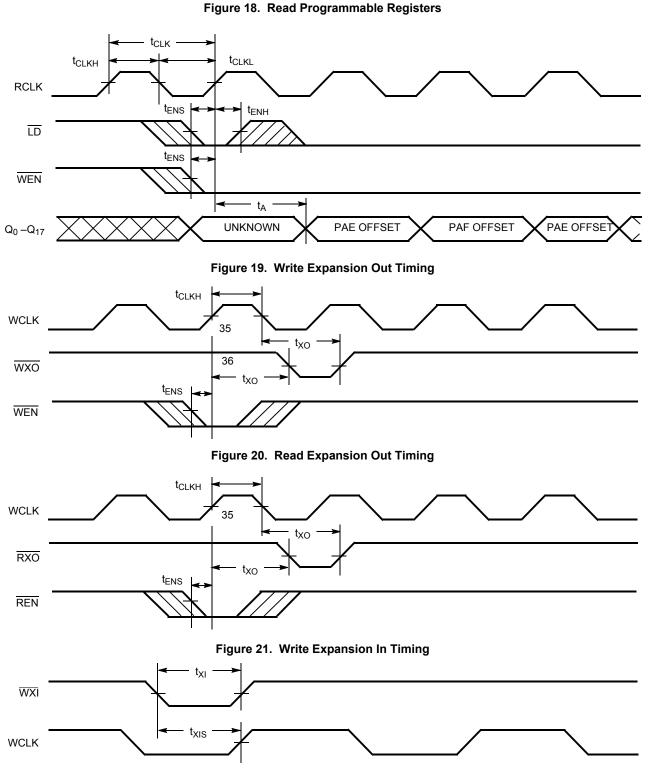




Notes

- 32. If a write is performed on this rising edge of the write clock, there are Full (m-1) words of the FIFO when PAF goes LOW.
- 33.8192 m words in CY7C4255V, 16384 m words in CY7C4265V, 32768 m words in CY7C4275V, and 65536 m words in CY7C4285V. 34. t_{SKEW3} is the minimum time between a rising RCLK and a rising WCLK edge for PAF to change state during that clock cycle. If the time between the edge of RCLK and the rising edge of WCLK is less than t_{SKEW3}, then PAF may not change state until the next WCLK rising edge.





Notes

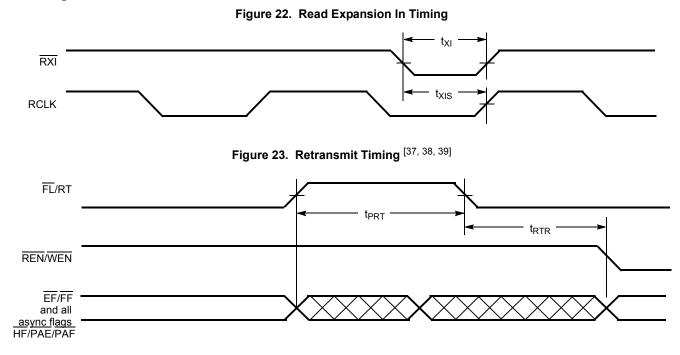
35. Read from Last Physical Location.

36. Write to Last Physical Location.

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Notes

37. Clocks are free-running in this case.
38. The flags may change state during Retransmit as a result of the offset of the read and write pointers, but flags are valid at t_{RTR}.
39. For the synchronous PAE and PAF flags (SMODE), an appropriate clock cycle is necessary after t_{RTR} to update these flags.

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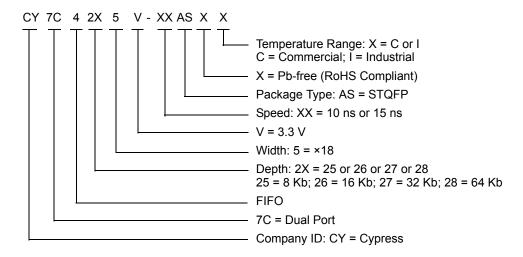
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Ordering Information

8 K × 18 Lo	w-Voltage Deep Sync	FIFO			
Speed (ns)	Ordering Code	Package Diagram	Package Type	Operating Range	
10	CY7C4255V-10ASC	51-85051	64-pin Thin Quad Flat Pack (10 × 10 × 1.4 mm)	Commercial	
	CY7C4255V-10ASXC	51-65051	64-pin Thin Quad Flat Pack (10 × 10 × 1.4 mm) (Pb-free)		
15	CY7C4255V-15ASC	51-85051	64-pin Thin Quad Flat Pack (10 × 10 × 1.4 mm)	Commercial	
	CY7C4255V-15ASXC	51-65051	64-pin Thin Quad Flat Pack (10 × 10 × 1.4 mm) (Pb-free)		
	CY7C4255V-15ASXI	51-85051	64-pin Thin Quad Flat Pack (10 × 10 × 1.4 mm) (Pb-free)	Industrial	
	CY7C4255V-15ASI		64-pin Thin Quad Flat Pack (10 × 10 × 1.4 mm)		
16 K × 18 L	ow-Voltage Deep Sync	FIFO			
Speed (ns)	Ordering Code	Package Diagram	Package Type	Operating Range	
15	CY7C4265V-15ASC	51-85051	64-pin Thin Quad Flat Pack (10 × 10 × 1.4 mm)	Commercial	
32 K × 18 L	ow-Voltage Deep Sync	FIFO			
Speed (ns)	Ordering Code	Package Diagram	Package Type	Operating Range	
15	CY7C4275V-15ASC	51-85051	64-pin Thin Quad Flat Pack (10 × 10 × 1.4 mm)	Commercial	
	CY7C4275V-15ASXC	51-65051	64-pin Thin Quad Flat Pack (10 × 10 × 1.4 mm) (Pb-free)	Commercial	
64 K × 18 L	ow-Voltage Deep Sync	FIFO		•	
Speed (ns)	Ordering Code	Package Diagram	Package Type	Operating Range	
10	CY7C4285V-10ASC	51-85051	64-pin Thin Quad Flat Pack (10 × 10 × 1.4 mm)	Commercial	
	CY7C4285V-10ASXC	51-65051	64-pin Thin Quad Flat Pack (10 × 10 × 1.4 mm) (Pb-free)		
15	CY7C4285V-15ASXC	51-85051	64-pin Thin Quad Flat Pack (10 × 10 × 1.4 mm) (Pb-free)	Commercial	
	CY7C4285V-15ASC		64-pin Thin Quad Flat Pack (10 × 10 × 1.4 mm)		
	CY7C4285V-15ASI	51-85051	64-pin Thin Quad Flat Pack (10 × 10 × 1.4 mm)	Industrial	
	CY7C4285V–15ASXI	1 00001	64-pin Thin Quad Flat Pack (10 × 10 × 1.4 mm) (Pb-free)	incustriai	

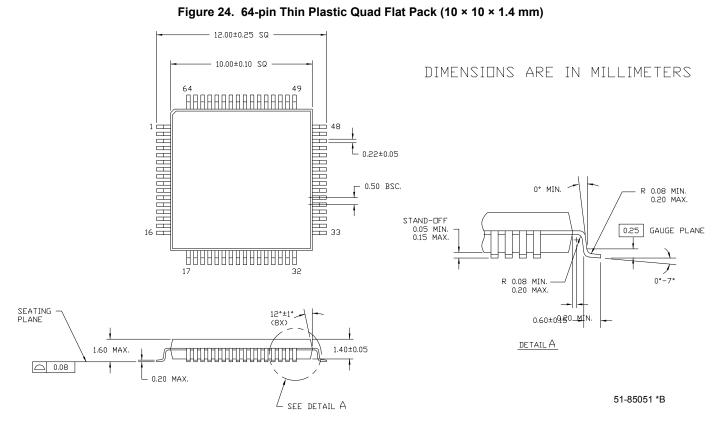
Ordering Code Definitions





CY7C4255V, CY7C4265V CY7C4275V, CY7C4285V

Package Diagram





Acronyms

Acronym	Description
CMOS	complementary metal oxide semiconductor
FIFO	first-in first-out
I/O	input/output
OE	output enable
REN	read enable
RCLK	read clock
RT	Retransmit
RS	Reset
TQFP	thin quad flat pack
WCLK	write clock
WEN	write enable

Document Conventions

Units of Measure

Symbol	Unit of Measure		
ns	nano seconds		
V	Volts		
μA	micro Amperes		
mA	milli Amperes		
ms	milli seconds		
mV	milli Volts		
MHz	Mega Hertz		
pF	pico Farad		
W	Watts		
°C	degree Celcius		



Document History Page

Document Title: CY7C4255V/CY7C4265V/CY7C4275V/CY7C4285V 8 K/16 K/32 K/64 K × 18 Low Voltage Deep Sync FIFOs Document Number: 38-06012				
REV.	ECN	Orig. of Change	Submission Date	Description of Change
**	106473	SZV	09/10/01	Change from Spec number: 38-00654 to 38-06012
*A	122264	RBI	12/26/02	Power up requirements added to Maximum Ratings Information
*В	2556036	VKN/AESA	08/22/2008	Updated ordering information and data sheet template.
*C	2896039	RAME	03/19/2010	Added Contents Updated package diagram Removed inactive parts from Ordering information table Updated links in Sales, Solutions and Legal Information
*D	3123000	ADMU	12/31/2010	Removed speed bin -25 Added Ordering Code Definitions. Added Acronyms and Units of Measure. Updated in new template.

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